



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:

Salman Akram

Serial No.: 09/853,111

Filed: May 10, 2001

For: Method of Fabricating Mounted
Multiple Semiconductor Dies
In a Package (As Amended)

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Art Unit: 2827

Examiner: Alonzo Chambliss

Atty Docket: MCT.0012D1US
97-0141.02

Mail Stop **RCE**
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

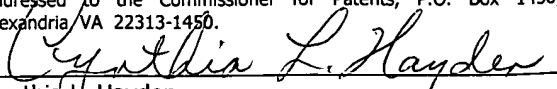
PRELIMINARY AMENDMENT

Sir:

Prior to the receipt of an office action, please amend the above-referenced patent application as follows:

Date of Deposit: October 6, 2005

I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as **first class mail** with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.


Cynthia L. Hayden